

#	Layer	Thickness	Description	Dk	Df	Note
	Top Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028	used on rigid parts
1	Top Side	0.035mm	Starting foil 1/2oz. after plating and processing			
		0.370mm	Prepreg IPC-4101/127/128	4,6	0,011	FR-4.1 filled, halogen free
2	Inner Layer 1	0.017mm	ED Base Copper			
		0.510mm	Core IPC-4101/127/128	5,1	0,011	FR-4.1 filled, halogen free
3	Inner Layer 2	0.017mm	ED Base Copper			
		0.370mm	Prepreg IPC-4101/127/128	4,6	0,011	FR-4.1 filled, halogen free
4	Inner Layer 3	0.017mm	ED Base Copper			
		0.510mm	Core IPC-4101/127/128	5,1	0,011	FR-4.1 filled, halogen free
5	Inner Layer 4	0.017mm	ED Base Copper			
		0.370mm	Prepreg IPC-4101/127/128	4,6	0,011	FR-4.1 filled, halogen free
6	Bottom Side	0.035mm	Starting foil 1/2oz. after plating and processing			
	Bottom Solder	0.015mm	Soldermask IPC-SM840	3,5	0,028	used on rigid parts

Total thickness: 2.298mm

Würth Elektronik GmbH & Co. KG
Circuit Board Technology

BASIC6_ML6_2,30_17_V2.12

notes:

PCB Thickness Tolerance: ± 10%

Final copper thickness according to IPC-6012

customer		created	
pcb name		approved	
engineer		format	A4, landscape
date			

Please regard to our sectional design rules:
► www.we-online.com

Template Revision: 02/2021 by Andreas Schilpp / Michael Kress / Werner Öchslen

